

2/22/02

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Dear Applicant:

The Box PGPub replacement drawings for application number 10/038,806 received on 2/12/02 by the U. S. Patent and Trademark Office will be included for patent publication.

Telephone inquiries should be directed to Customer Service, Office of Initial Patent Examination, at 703-308-1202.



Signature of Reviewer, Office of Initial Patent Examination

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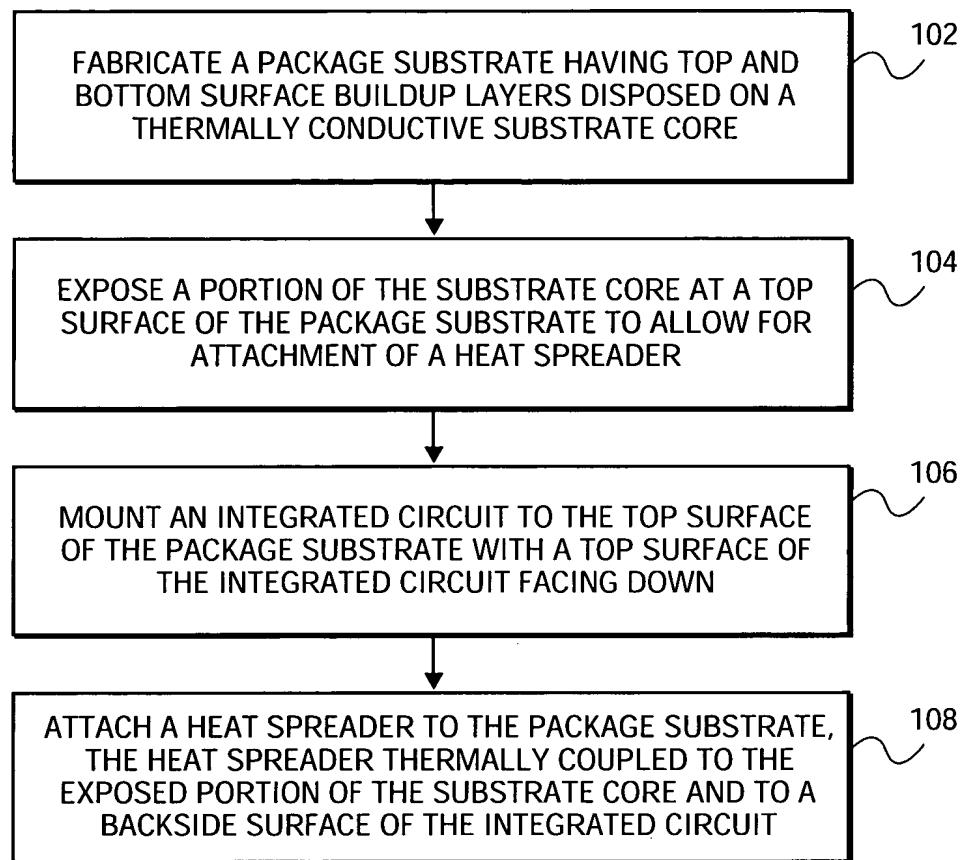


FIG. 1

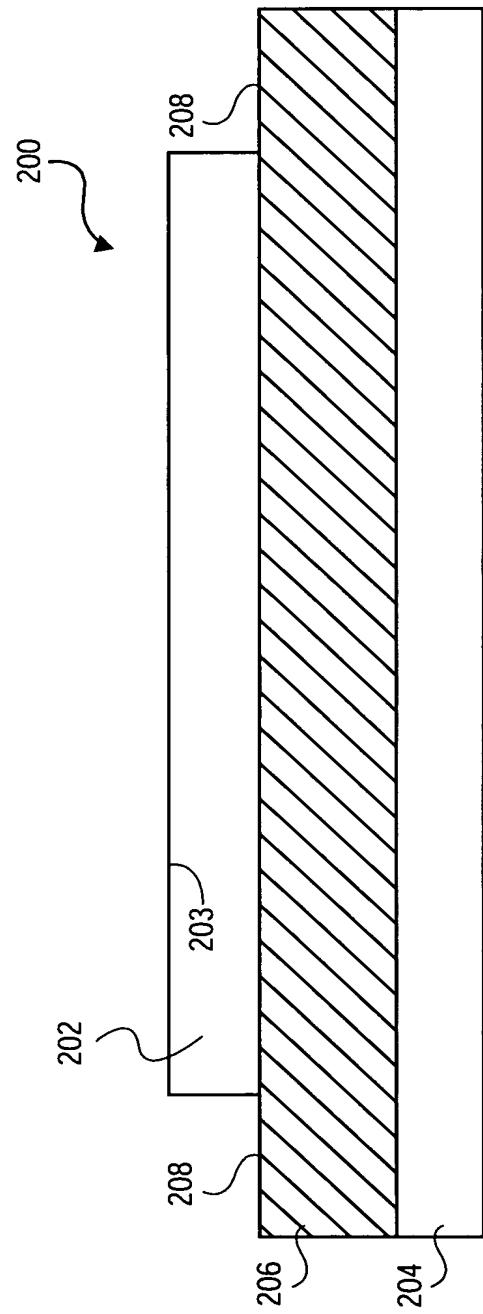


FIG. 2

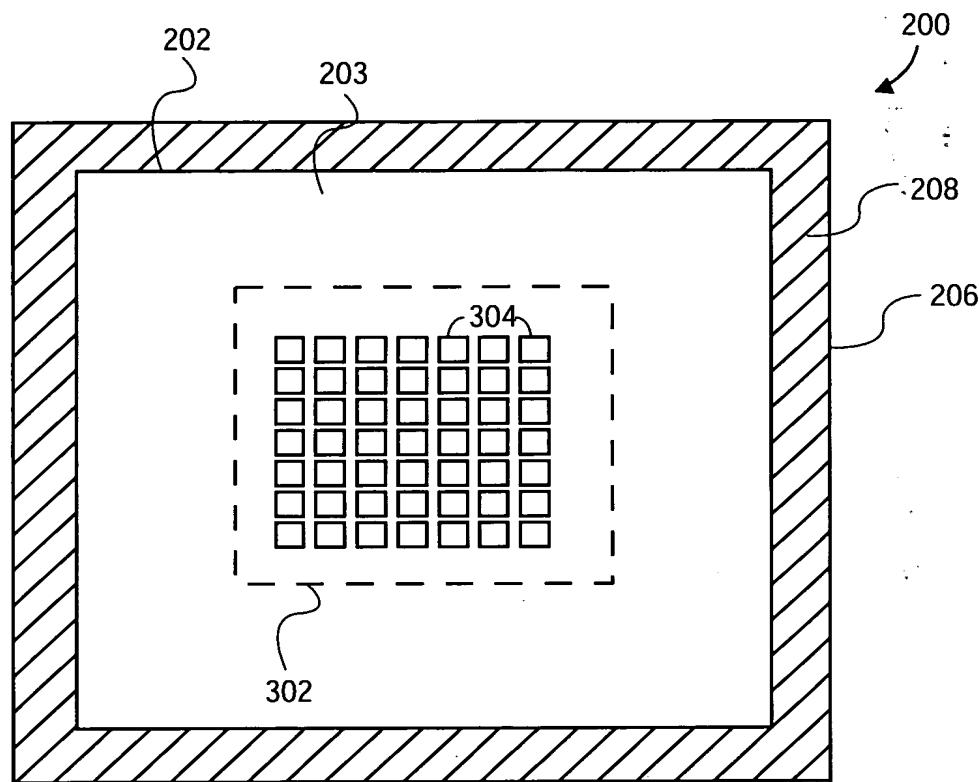


FIG. 3

TITLE: SEMICONDUCTOR PACKAGE WITH INTEGRATED HEAT SPREADER ATTACHED TO A
THERMALLY CONDUCTIVE SUBSTRATE CORE
INVENTOR(S): TIMOTHY M. TAKEUCHI
APPLICATION NO.: 10,038,806

4/7

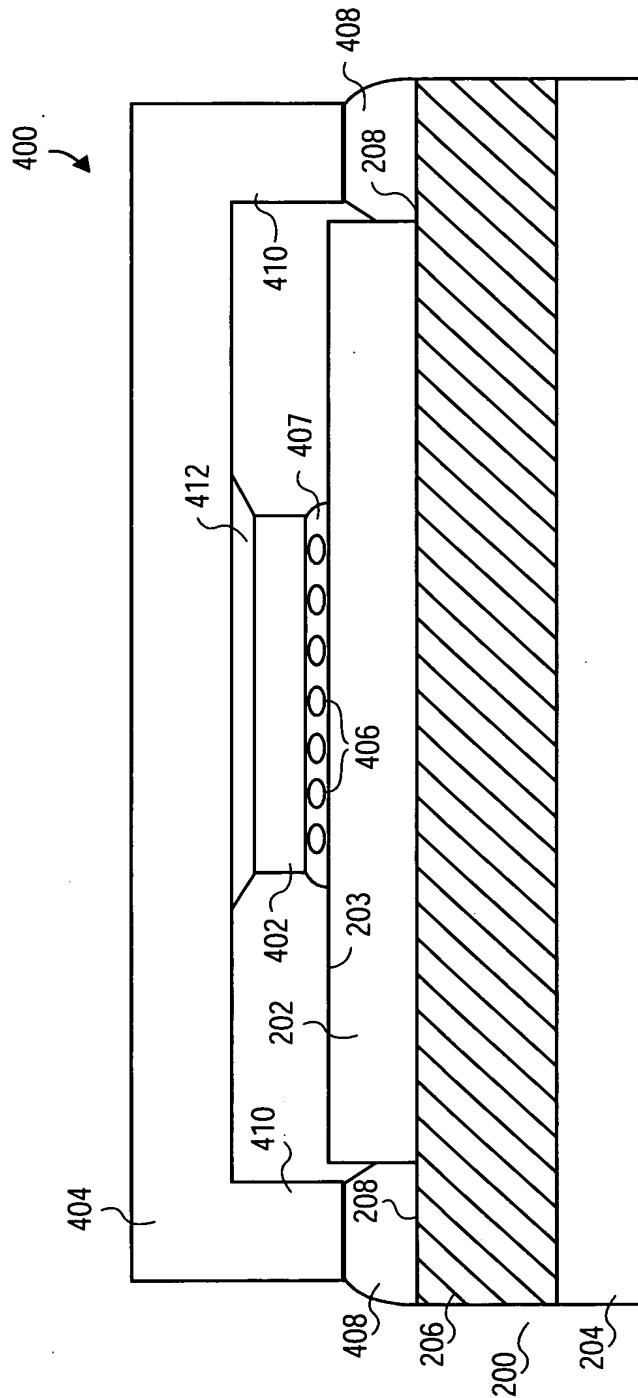


FIG. 4

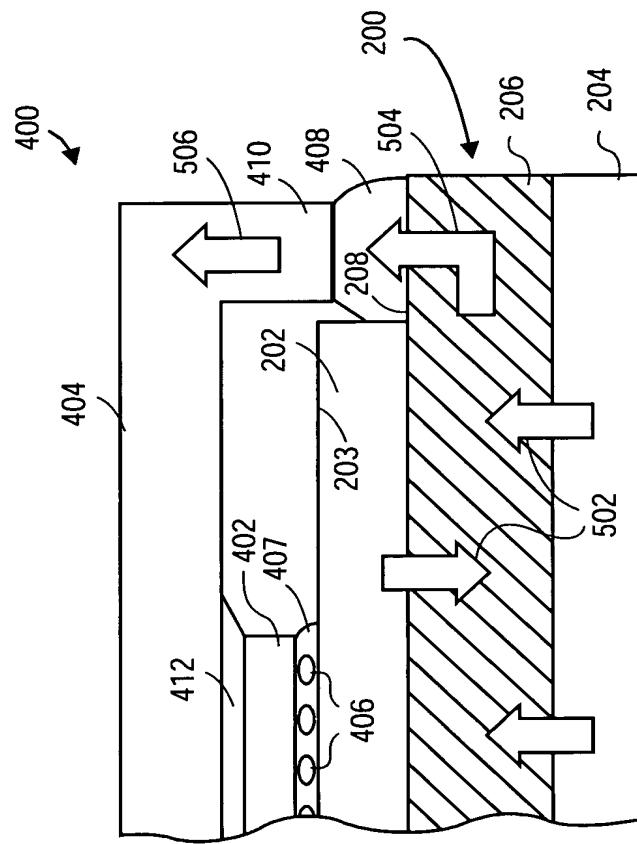


FIG. 5

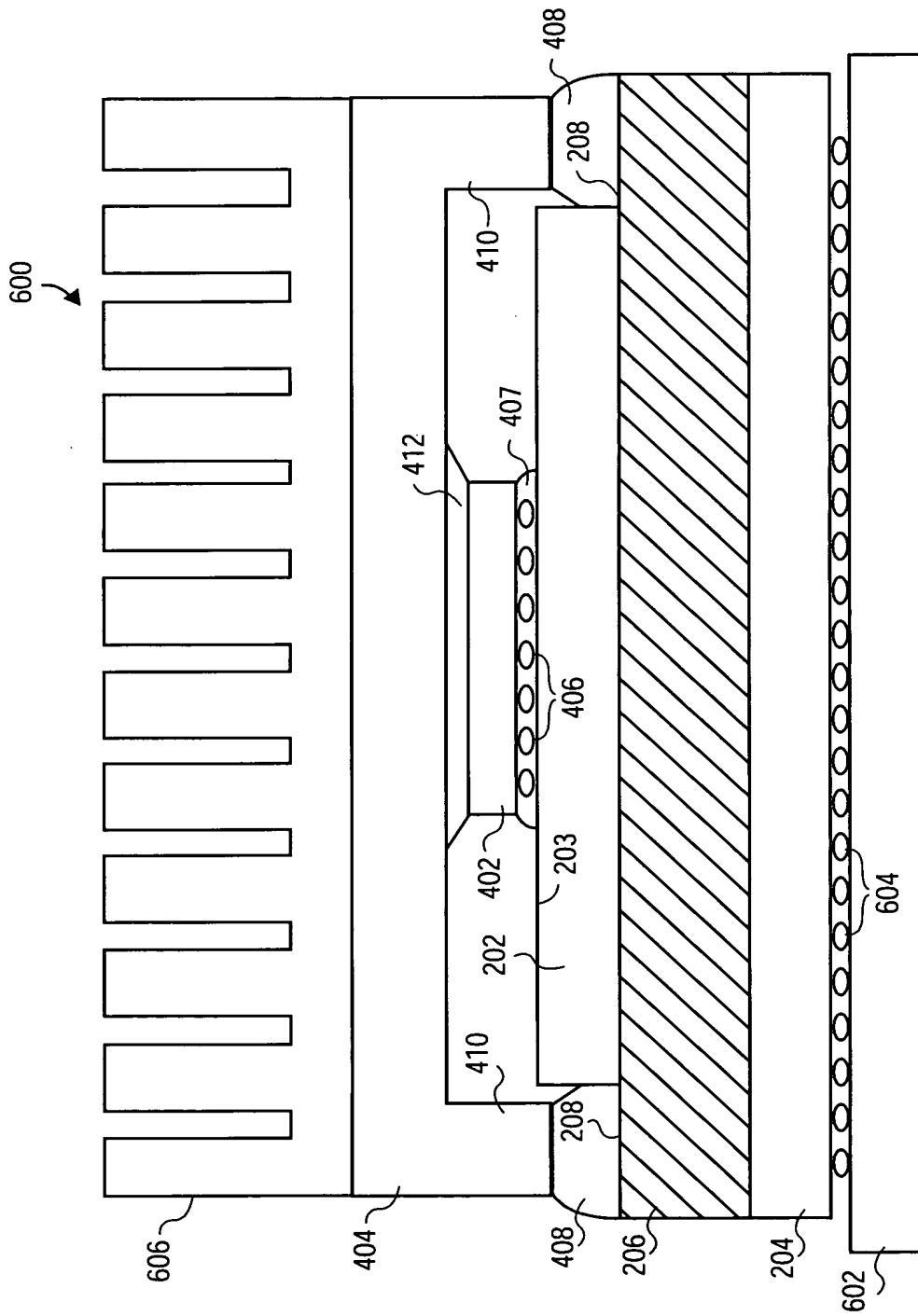


FIG. 6

TITLE: SEMICONDUCTOR PACKAGE WITH INTEGRATED HEAT SPREADER ATTACHED TO A
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7/7

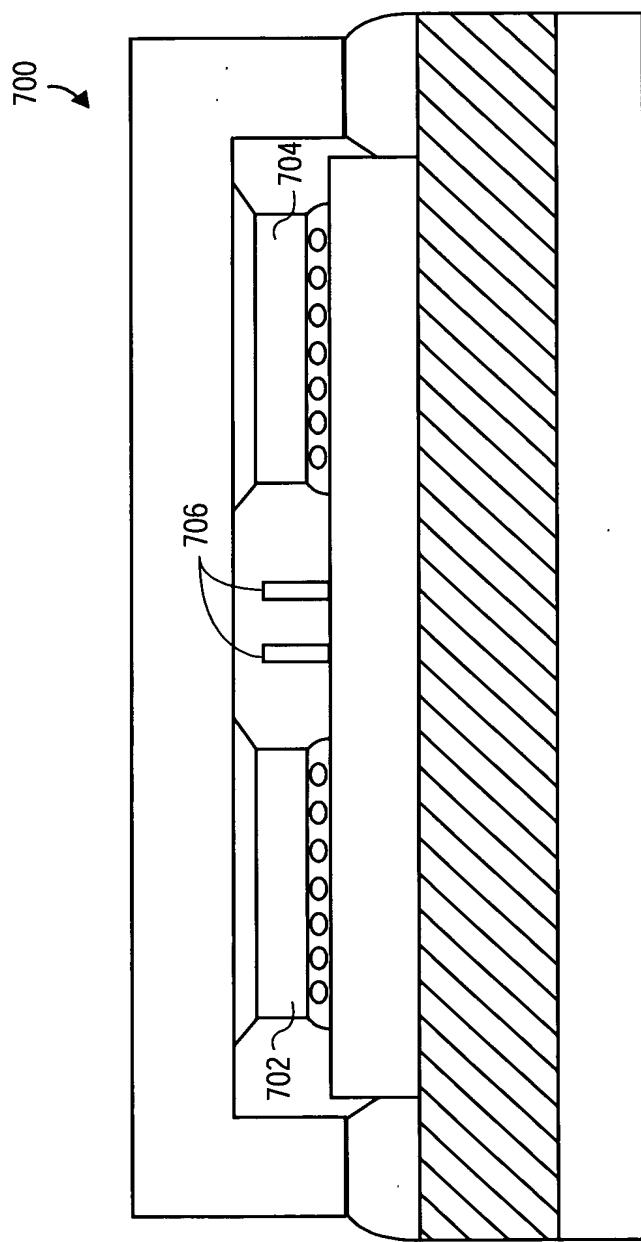


FIG. 7